

## PSMN8R5-40MSD

N-channel 40 V, 8.5 mΩ, standard level MOSFET in LFPAK33 using NextPower-S3 technology

10 February 2020

**Product data sheet** 

#### 1. General description

60 A, standard level N-channel enhancement mode MOSFET in 175 °C LFPAK33 package using advanced TrenchMOS Superjunction technology. This product has been designed and qualified for high efficiency applications at high switching frequencies.

#### 2. Features and benefits

- Avalanche rated, 100% tested
- NextPower-S3 technology delivers 'superfast switching with soft body-diode recovery'
- · Low Q<sub>RR</sub>, Q<sub>G</sub> and Q<sub>GD</sub> for high system efficiency, especially at high switching frequencies
- · Low spiking and ringing for low EMI designs
- High reliability clip bonded and solder die attach Mini Power SO8 package; no glue, no wire bonds, qualified to 175 °C
- Exposed leads can be wave soldered, visual solder joint inspection and high quality solder joints
- Low parasitic inductance and resistance

### 3. Applications

- Secondary side synchronous rectification
- DC-to-DC converters
- Brushless DC motor drive
- LED lighting

### 4. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage	25 °C ≤ T <sub>j</sub> ≤ 175 °C		-	-	40	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 25 °C; <u>Fig. 2</u>	[1]	-	-	60	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; <u>Fig. 1</u>		-	-	59	W
Tj	junction temperature			-55	-	175	°C
Static chara	acteristics						
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 15 A; T <sub>j</sub> = 25 °C; Fig. 10		-	7.4	8.5	mΩ
Dynamic ch	naracteristics						
Q <sub>GD</sub>	gate-drain charge	$I_D$ = 15 A; $V_{DS}$ = 20 V; $V_{GS}$ = 10 V;		0.6	2	4	nC
Q <sub>G(tot)</sub>	total gate charge	Fig. 12; Fig. 13		9	13.4	19	nC

[1] 60A Continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.

# ne<mark>x</mark>peria

### 5. Pinning information

Table 2.	. Pinning infor	mation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source		D
2	S	source		
3	S	source		G-UH
4	G	gate		mbb076 S
mb	D	Mounting base; connected to drain	LFPAK33 (SOT1210)	

### 6. Ordering information

Table 3. Ordering information							
Type number	Package						
	Name	Description	Version				
PSMN8R5-40MSD	LFPAK33	Plastic, single ended surface mounted package (LFPAK33); 8 leads; 0.65 mm pitch	SOT1210				

#### 7. Marking

	Table 4.	Marking	codes	
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Type number	Marking code
PSMN8R5-40MSD	8D5S40

### 8. Limiting values

#### Table 5. Limiting values

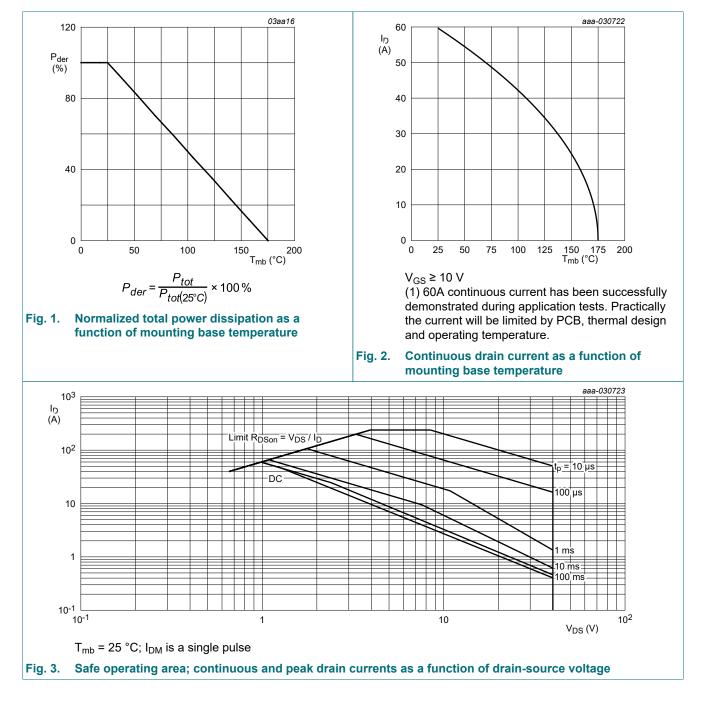
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	25 °C ≤ T <sub>j</sub> ≤ 175 °C		-	40	V
V <sub>DSM</sub>	peak drain-source voltage	$t_p \le 20 \text{ ns}; f \le 500 \text{ kHz}; E_{DS(AL)} \le 200 \text{ nJ};$ pulsed		-	45	V
V <sub>DGR</sub>	drain-gate voltage	25 °C ≤ $T_j$ ≤ 175 °C; $R_{GS}$ = 20 kΩ		-	40	V
V <sub>GS</sub>	gate-source voltage			-20	20	V
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; <u>Fig. 1</u>		-	59	W
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 25 °C; <u>Fig. 2</u>	[1]	-	60	А
		V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 100 °C; <u>Fig. 2</u>		-	42	А
I <sub>DM</sub>	peak drain current	pulsed; $t_p \le 10 \ \mu s$ ; $T_{mb} = 25 \ ^\circ C$ ; Fig. 3		-	239	А
T <sub>stg</sub>	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
T <sub>sld(M)</sub>	peak soldering temperature			-	260	°C
Source-draii	n diode					
I <sub>S</sub>	source current	T <sub>mb</sub> = 25 °C		-	59	А

Symbol	Parameter	Conditions		Min	Max	Unit
I <sub>SM</sub>	peak source current	pulsed; $t_p \le 10 \ \mu s$ ; $T_{mb} = 25 \ ^{\circ}C$		-	239	А
Avalanche ru	uggedness		•			
E <sub>DS(AL)S</sub>	non-repetitive drain- source avalanche energy	$ \begin{split} &I_{D} = 22 \text{ A};  V_{sup} \leq \ 40 \text{ V};  R_{GS} = 50 \ \Omega; \\ &V_{GS} = 10 \text{ V};  T_{j(init)} = 25 \ ^{\circ}\text{C};  unclamped; \\ &t_{p} = 80 \ \mu\text{s} \end{split} $	[2]	-	46	mJ
		$ \begin{split} &I_{D} = 15 \text{ A};  V_{sup} \leq \ 40 \text{ V};  R_{GS} = 50 \ \Omega; \\ &V_{GS} = 10 \text{ V};  T_{j(init)} = 25 \ ^{\circ}\text{C};  unclamped; \\ &t_{p} = 180 \ \mu\text{s} \end{split} $	[2]	-	70	mJ

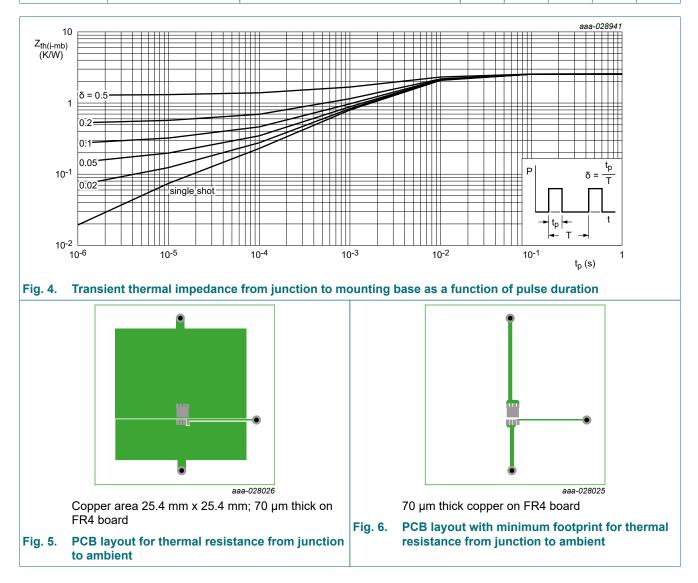
[1] 60A Continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.

[2] Protected by 100% test



#### 9. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
R <sub>th(j-mb)</sub>	thermal resistance from junction to mounting base	Fig. <u>4</u>	-	2.33	2.56	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	Fig. 5	-	50	-	K/W
		Fig. 6	-	130	-	K/W

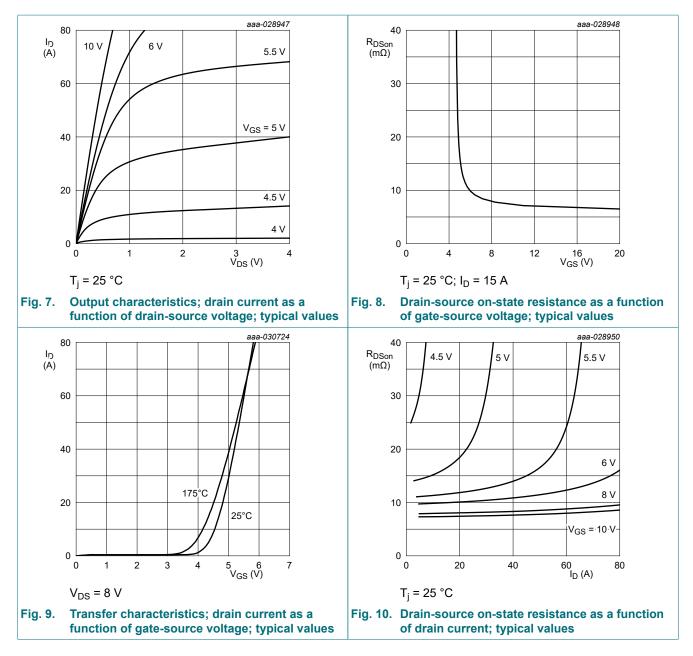


### **10. Characteristics**

Table 7. Characteristics								
Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
Static characteristics								
V <sub>(BR)DSS</sub>	drain-source	$I_D$ = 250 µA; $V_{GS}$ = 0 V; $T_j$ = 25 °C		40	-	-	V	
	breakdown voltage	$I_D$ = 250 µA; $V_{GS}$ = 0 V; $T_j$ = -55 °C		36	-	-	V	

-	_						
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
V <sub>GS(th)</sub>	gate-source threshold voltage	I <sub>D</sub> = 1 mA; V <sub>DS</sub> =V <sub>GS</sub> ; T <sub>j</sub> = 25 °C		2.4	3.12	3.6	V
ΔV <sub>GS(th)</sub> /ΔT	gate-source threshold voltage variation with temperature	25 °C ≤ T <sub>j</sub> ≤ 150 °C		-	-5.9	-	mV/K
I <sub>DSS</sub>	drain leakage current	V <sub>DS</sub> = 32 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C		-	0.01	1	μA
		$V_{DS}$ = 32 V; $V_{GS}$ = 0 V; $T_j$ = 125 °C		-	1	-	μA
I <sub>GSS</sub>	gate leakage current	V <sub>GS</sub> = 20 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C		-	2	100	nA
		V <sub>GS</sub> = -20 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C		-	2	100	nA
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 15 A; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>		-	7.4	8.5	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 15 A; T <sub>j</sub> = 175 °C; <u>Fig. 11</u>		-	-	16.5	mΩ
R <sub>G</sub>	gate resistance	f = 1 MHz; T <sub>j</sub> = 25 °C		0.3	0.8	2	Ω
Dynamic cha	racteristics						
Q <sub>G(tot)</sub>	total gate charge	$I_D$ = 15 A; $V_{DS}$ = 20 V; $V_{GS}$ = 10 V; Fig. 12; Fig. 13		9	13.4	19	nC
		$I_D = 0 \text{ A}; V_{DS} = 0 \text{ V}; V_{GS} = 10 \text{ V}$		-	8.8	-	nC
Q <sub>GS</sub>	gate-source charge	I <sub>D</sub> = 15 A; V <sub>DS</sub> = 20 V; V <sub>GS</sub> = 10 V; Fig. 12; Fig. 13		2.7	4.5	6.8	nC
Q <sub>GS(th)</sub>	pre-threshold gate- source charge			1.7	2.9	4.4	nC
$Q_{GS(th-pl)}$	post-threshold gate- source charge			1	1.7	2.6	nC
Q <sub>GD</sub>	gate-drain charge			0.6	2	4	nC
V <sub>GS(pl)</sub>	gate-source plateau voltage	I <sub>D</sub> = 15 A; V <sub>DS</sub> = 20 V; <u>Fig. 12; Fig. 13</u>		-	4.7	-	V
C <sub>iss</sub>	input capacitance	V <sub>DS</sub> = 20 V; V <sub>GS</sub> = 0 V; f = 1 MHz;		614	944	1322	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C; <u>Fig. 14</u>		266	409	573	pF
C <sub>rss</sub>	reverse transfer capacitance			13	44	97	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS}$ = 20 V; $R_L$ = 1.2 $\Omega$ ; $V_{GS}$ = 10 V;		-	5.1	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 5 \Omega$		-	3.2	-	ns
t <sub>d(off)</sub>	turn-off delay time	-		-	8.9	-	ns
t <sub>f</sub>	fall time			-	2.8	-	ns
Q <sub>oss</sub>	output charge	V <sub>GS</sub> = 0 V; V <sub>DS</sub> = 20 V; f = 1 MHz; T <sub>j</sub> = 25 °C		-	12	-	nC
Source-drain	diode						
V <sub>SD</sub>	source-drain voltage	$I_{S}$ = 15 A; $V_{GS}$ = 0 V; $T_{j}$ = 25 °C; <u>Fig. 15</u>		-	0.85	1	V
t <sub>rr</sub>	reverse recovery time	$I_{S} = 15 \text{ A}; \text{ dI}_{S}/\text{dt} = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V};$		-	22	-	ns
Q <sub>r</sub>	recovered charge	V <sub>DS</sub> = 20 V; <u>Fig. 16</u>	[1]	-	15	-	nC
t <sub>a</sub>	reverse recovery rise time			-	14	-	ns
t <sub>b</sub>	reverse recovery fall time			-	8.5	-	ns

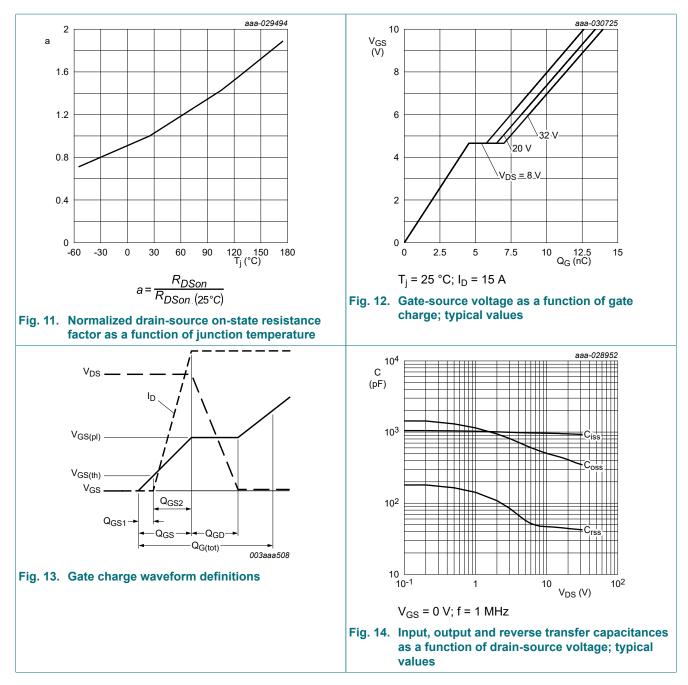
[1] includes capacitive recovery



**Product data sheet** 

### PSMN8R5-40MSD

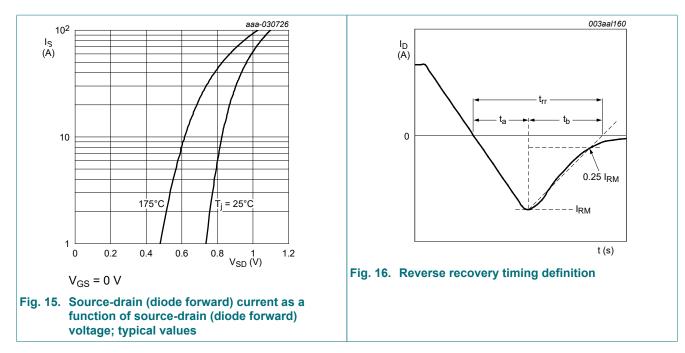
#### N-channel 40 V, 8.5 mΩ, standard level MOSFET in LFPAK33 using NextPower-S3 technology



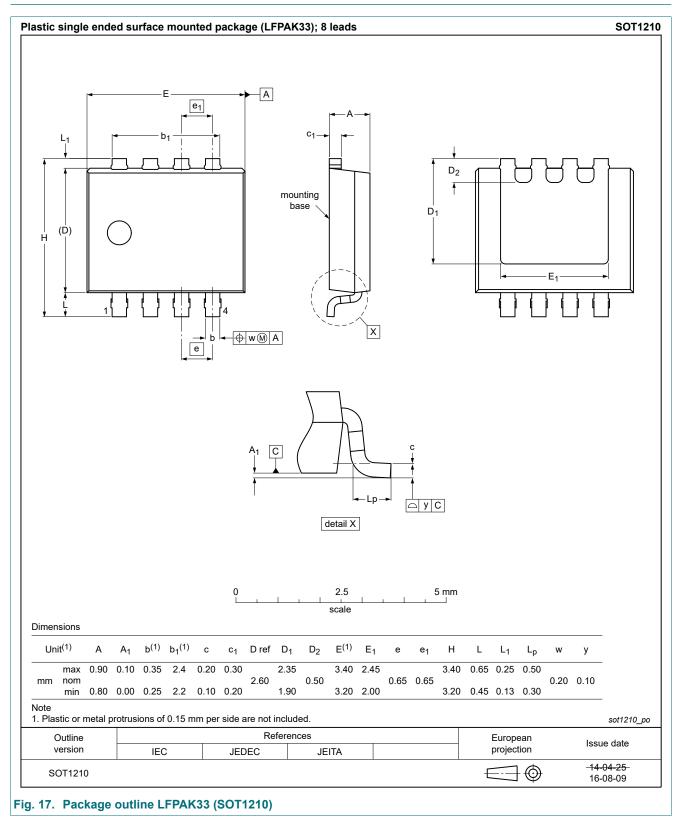
**Product data sheet** 

### PSMN8R5-40MSD

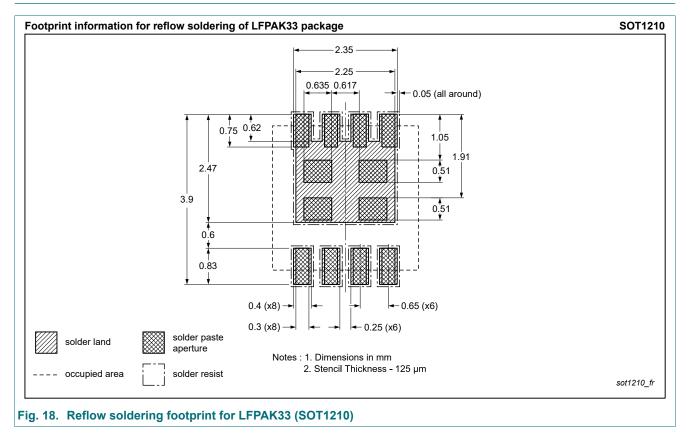
#### N-channel 40 V, 8.5 mΩ, standard level MOSFET in LFPAK33 using NextPower-S3 technology



### 11. Package outline



### 12. Soldering



### 13. Legal information

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Document status [1][2]	Product status [3]	Definition			
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.			
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